



EMPL-G2P2

mPCIe to dual PoE+ Module

Customer:

Customer

Part Number:

Innodisk

Part Number:

Innodisk

Model Name:

Date:

Innodisk	Customer
Approver	Approver

Total Solution For
Embedded Peripherals

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REVISION HISTORY

Revision	Description	Date
1.0	First Released	Jan, 2021

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1. Product Introduction

1.1. Overview

Innodisk EMPL-G2P2 is Mini PCI Express form factor PoE+ card which supports dual GbE 802.33at(PoE+) compliant Ethernet ports. With 19V~24V power input via 4pin header, the EMPL-G2P2 can provide up to 25.5 watts at 52 VDC power to dual ports at same time. It allows power to be supplied to powered devices, such like PoE IP camera or PoE Wifi AP, which brings you a flexible expansion solution for embedded systems.

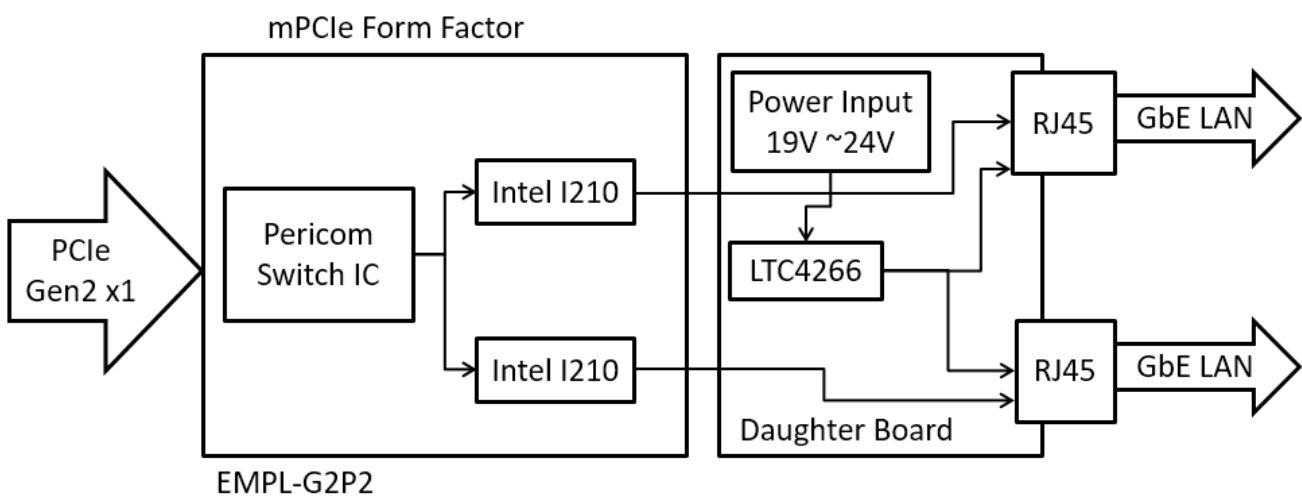


Figure 1: Block Diagram

1.2. Features

- Supports dual GbE LAN ports
- Two independent PSE channels
- Supports 19V~24V ($\pm 5\%$) power input via 4pin header
- Complies with IEEE 802.3at, up to 25.5W at 52V per PoE port.
- Complies with EN61000-4-2 (ESD) Air-15kV, Contact-8kV
- Industrial temperature -40 °C to 85 °C

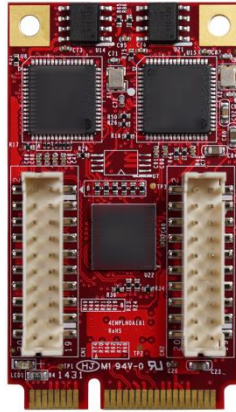


Figure 2: mPCIe Board Picture

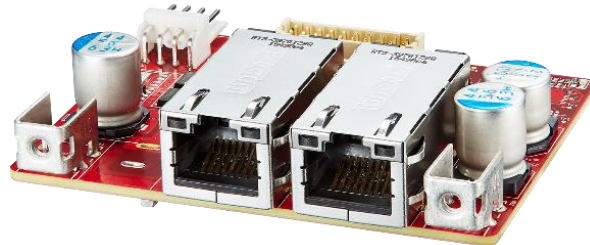


Figure 3: Mounting Hole, 4Pin Header, Daughter Board Picture (EMPL-G2P2-C1/W1)

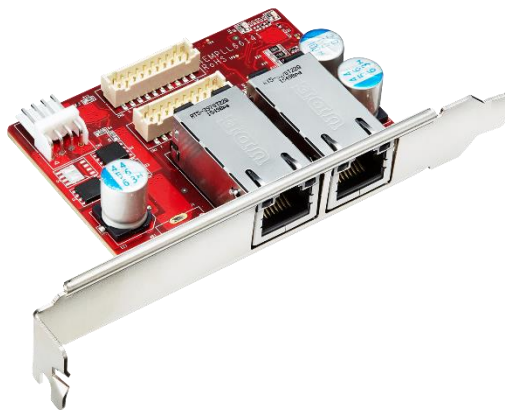


Figure 4: Bracket, 4Pin Header, Daughter Board Picture (EMPL-G2P2-C2/W2)

2. Product Specifications

2.1. Device Parameters

Table 1: Device Parameters

Form Factor	mPCIe
Input I/F	PCI Express 2.1 x 1
Output I/F	PoE+ x 2
Output Connector	RJ45 x 2
Dimension (WxLxH)	mPCIe Board: 30 x 50.9 x 7.6 mm Daughter Board: 72.7 x 58.2 x 23.8

2.2. Electrical Specifications

2.2.1. Power Requirement

Table 2: Power Requirement

Item	Connector	Rating
Main Board	mPCIe Golden Finger	+3.3 VDC +-5%
Daughter Board	4Pin Header	19 ~ 24 VDC

2.2.2. Power Consumption

Table 3: Power Consumption

	Full Load (mA)	Voltage (V)
Main Board	450	3.3
Daughter Board	3070	19

2.3. Environmental Specifications

2.3.1. Temperature Ranges

Table 4: Temperature Ranges

Temperature	Range
Operating	Standard Grade: 0°C to +70°C Industrial Grade: -40°C to +85°
Storage	-55°C to +95°

2.3.2. Humidity

Relative Humidity: 10-95%, non-condensing

2.3.3. Shock and Vibration

Table 5: Shock and Vibration

Reliability	Test Conditions	Reference Standards
Vibration	7 Hz to 2K Hz, 20G, 3 axes	IEC 68-2-6
Mechanical Shock	Duration: 0.5ms, 1500 G, 3 axes	IEC 68-2-27

2.3.4. Mean Time between Failure (MTBF)

Reliability prediction methodology provides the basis for reliability evaluation and analysis. The purpose of the prediction is to predict the life time of the product in units of failure rate and MTBF.

Table 6: Mean Time between Failure (MTBF)

Product	Condition	MTBF (Hours)
EMPL-G2P2	The analysis is at 25°C ambient temperature by Telcordia SR-332, Issues 4, Method I, Case 3 under Ground Benign, Controlled environment, 50% operation stress	TBD

2.4. CE and FCC Compatibility

EMPL-G2P2 conforms to CE and FCC requirements.

2.5. RoHS Compliance

EMPL-G2P2 is fully compliant with RoHS directive.

2.6. Hardware

2.6.1. Layout

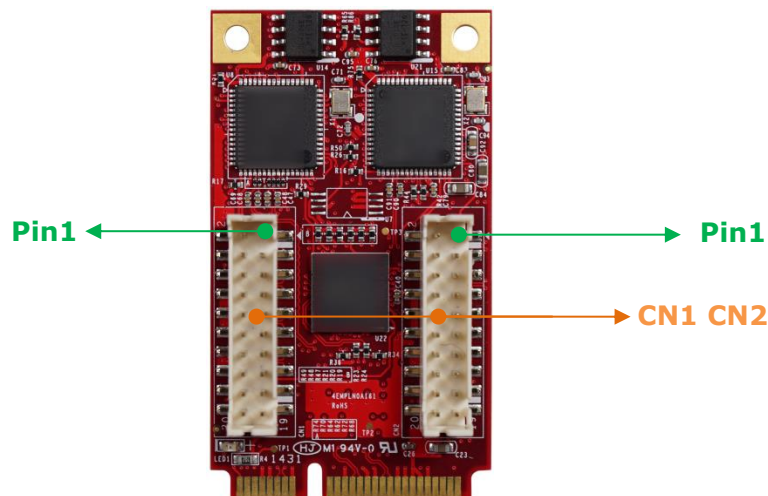


Table 7: mPCIe PCB Layout Legend

Label	Connector Type	Function
CN1/CN2	Wire to board SMD 2*10P 180° P:2.00mm H:4.0mm	GbE LAN Signal 10/100/1000 LED Signal

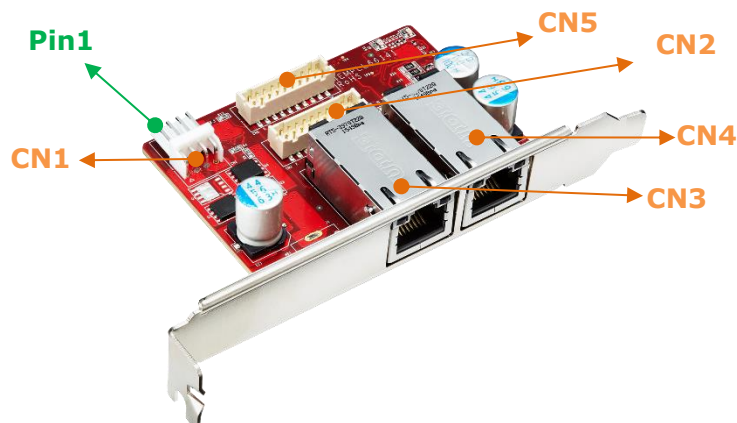


Table 8: Daughter Board PCB Layout Legend

Label	Connector Type	Function
CN1	4Pin Header	4Pin Header Power Input
CN3/ CN4	10/100/1000 Base-T RJ45 PoE DIP 16P16C 90° LED: Green-Orange/Green	PoE GbE LAN Port 10/100/1000 LED Indicator
CN2/ CN5	Wire to board SMD 2*10P 180° P:2.00mm H:4.0mm	GbE LAN Signal 10/100/1000 LED Signal

2.6.2. Pin Define

Table 9: mPCIe Pin Define

Signal Name	Pin #	Pin #	Signal Name
NC	51	52	3.3V AUX
NC	49	50	GND
NC	47	48	NC
NC	45	46	NC
GND	43	44	NC
3.3V AUX	41	42	NC
3.3V AUX	39	40	GND
GND	37	38	NC
GND	35	36	NC
RX+	33	34	GND
RX-	31	32	SMBDATA
GND	29	30	SMBCLK
GND	27	28	NC
TX+	25	26	GND
TX-	23	24	3.3V AUX
GND	21	22	PERST#
NC	19	20	NC
NC	17	18	GND
GND	15	16	NC
CLK+	13	14	NC
CLK-	11	12	NC
GND	9	10	NC
GND	7	8	NC
NC	5	6	NC
NC	3	4	GND
PE_WAKE_N	1	2	3.3V AUX

Table 10: 4Pin Header Power Input Pin Define

Pin #	Signal Name
1	NC
2	GND
3	GND
4	19V-24V

2.6.3. I/O Connector Mechanical Drawing & Pin Defines

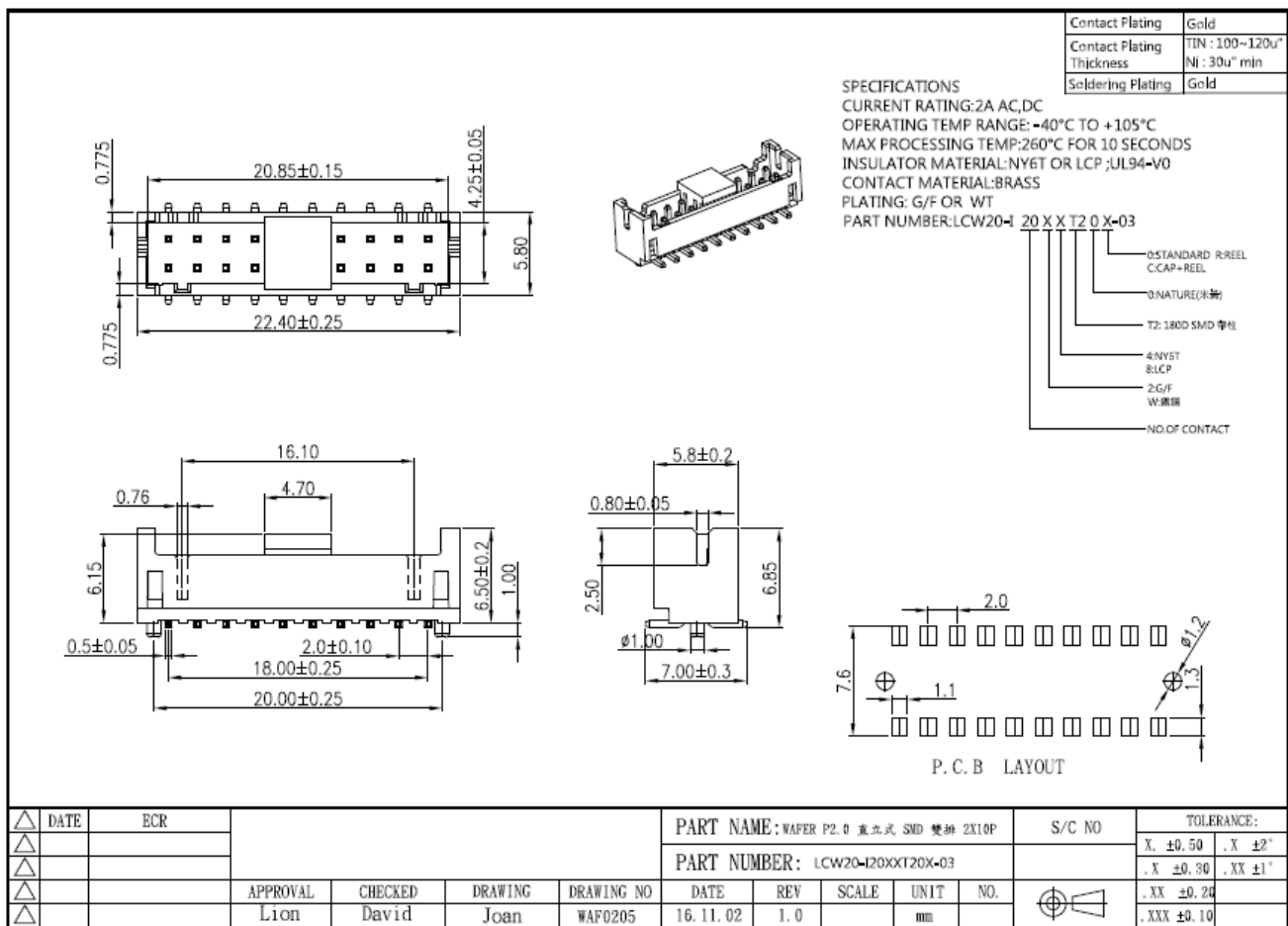


Figure 5: Wire to Board SMD 2*10P Connector Drawing

Table 11: Wire to Board SMD2*10P Connector Pin Define

Signal Name	Pin #	Pin #	Signal Name
LINK_100_N	2	1	MDI0P_IC
LINK_ACT_N	4	3	MDI0N_IC
LINK_1000_N	6	5	MDI1P_IC
GND	8	7	MDI1N_IC

GND	10	9	MDI2P_IC
GND	12	11	MDI2N_IC
3.3V	14	13	MDI3P_IC
3.3V	16	15	MDI3N_IC
NC	18	17	NC
NC	20	19	NC

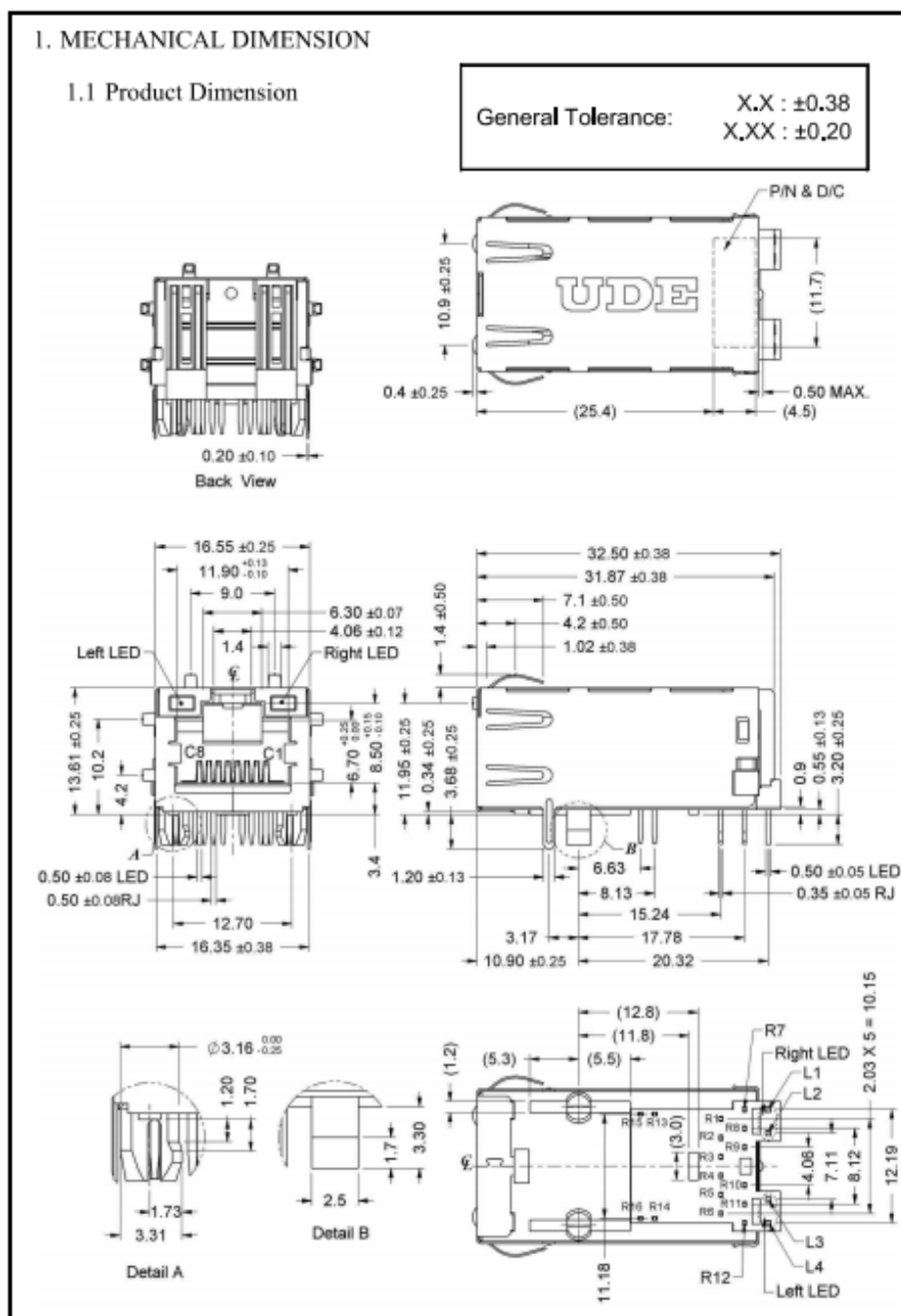
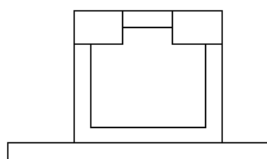


Figure 6: RJ45 Connector Drawing

Table 12: RJ45 LAN LED Table

Orange
/Green Green



Speed	Orange/Green (Status)	Green (Active/Link)
10M	OFF	Flash
100M	ON (Green)	Flash
1G	ON (Orange)	Flash

2.6.4. EMPL-G2P2 Mechanical Drawing

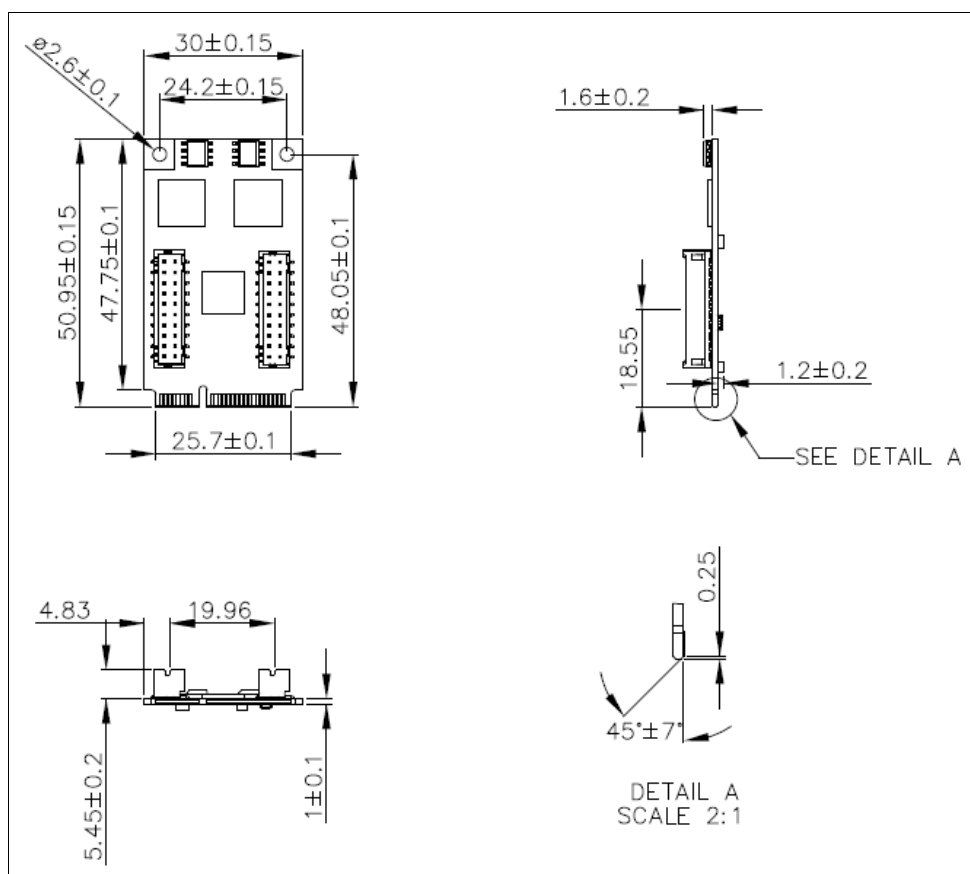


Figure 7: EMPL-G2P2 mPCIe Board Drawing

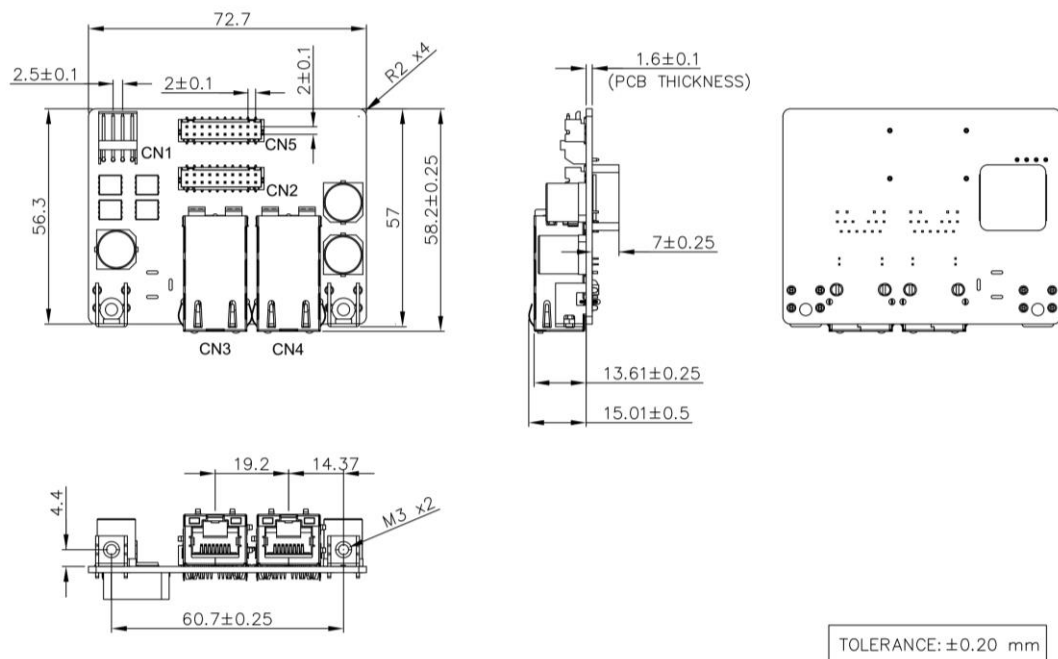


Figure 8: Mounting Hole Daughter Board Drawing - 4Pin Header (EMPL-G2P2-C1/W1)

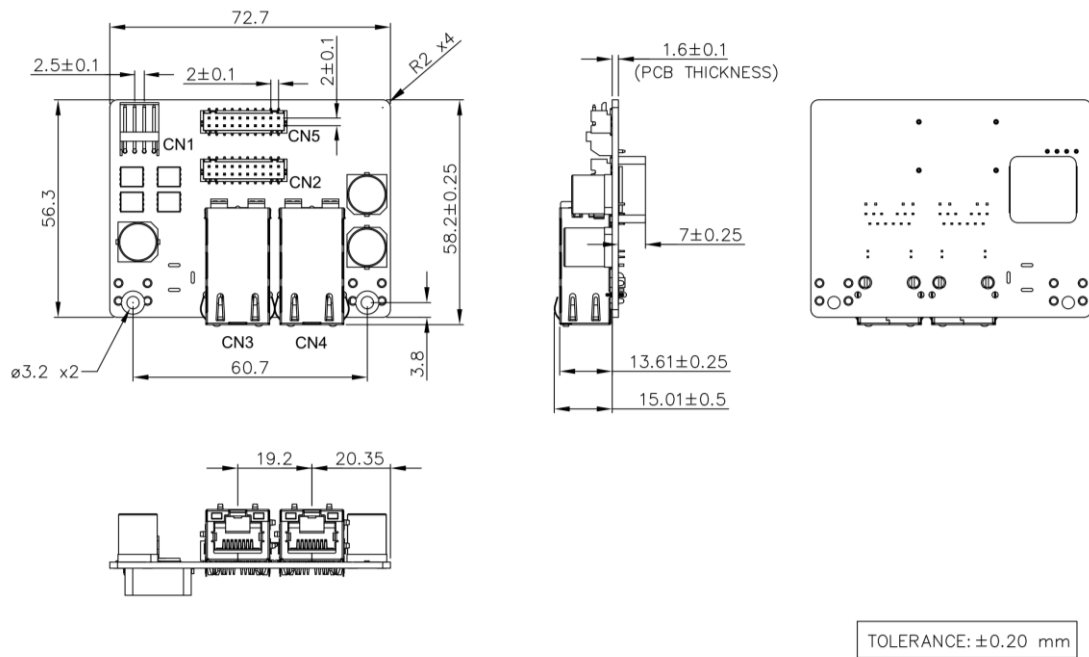


Figure 9: Bracket Daughter Board Drawing - 4Pin Header (EMPL-G2P2-C2/W2)

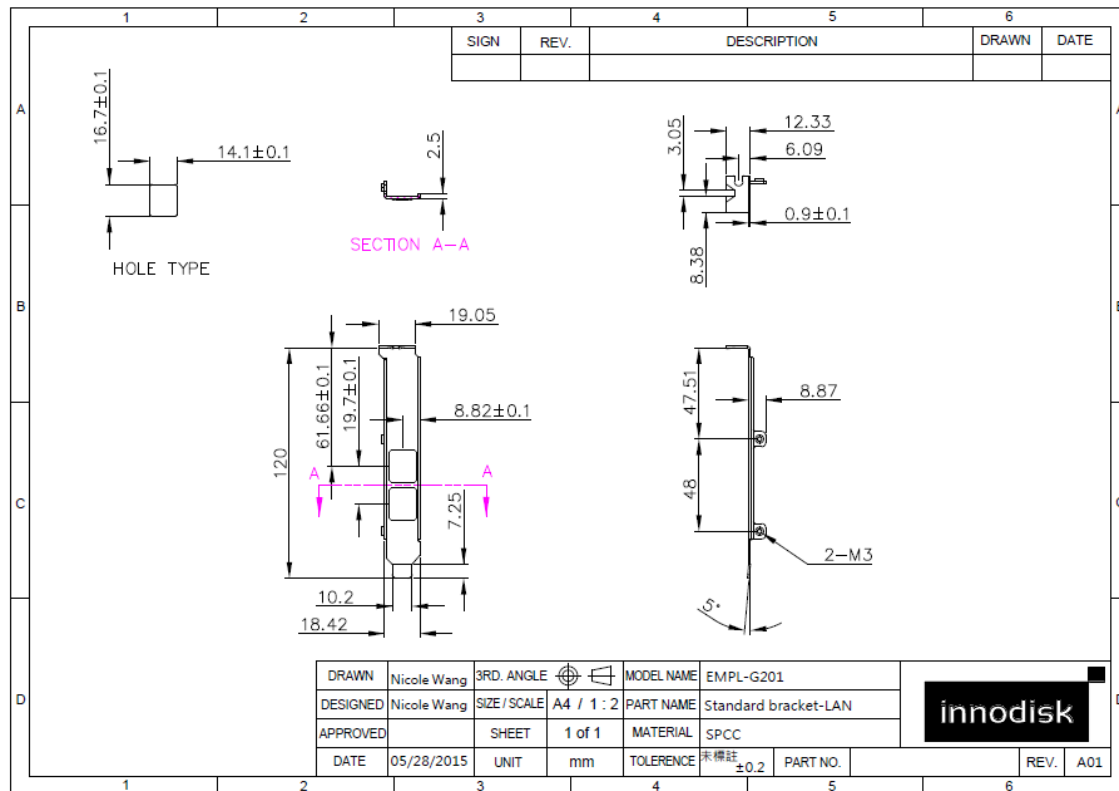


Figure 10: Bracket Drawing

2.6.5. Cable Mechanical Drawing

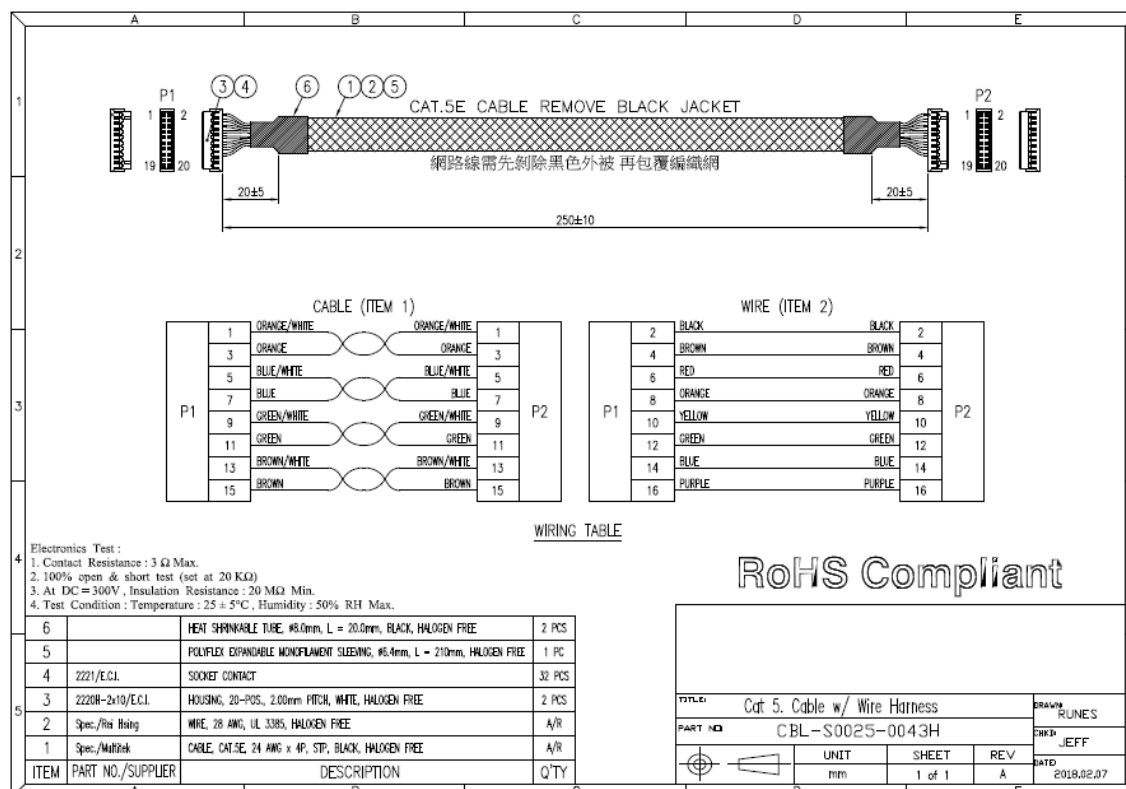


Figure 11: Board to Board LAN Cable Drawing

2.6.6. Packing List

- EMPL-G2P2 mPCIe Board x 1
- EMPL-G2P2 Daughter Board x 1
- Board to Board LAN Cable x 2
- Bracket x 1 (EMPL-G2P2-C2/W2 only)
- Screw M3*5 Silver x 2 (EMPL-G2P2-C2/W2 only)

2.7. Software Support

- Windows: XP(32bit), 7(32/64bit), 8/8.1(32/64 bit), 10(32/64bit)
- Linux: Kernel 2.4 above.

3. Installation Guide

Please download driver from Myinnodisk web site.

<https://myinnodisk.innodisk.com/myinnodisk/Login.aspx>

Or you can download intel i210 chip driver from intel official web site directly.

<https://downloadcenter.intel.com/product/64399/Intel-Ethernet-Controller-I210-Series>

4. Appedix

innodisk

宜鼎國際股份有限公司 Innodisk Corporation REACH Declaration

Tel:(02)7703-3000 Fax:(02) 7703-3555 Internet: <https://www.innodisk.com/>

Innodisk Corporation pursues its social responsibility for global environmental preservation by committing to be compliant with REACH regulation (REGULATION (EC) No 1907/2006). We hereby confirm that the product(s) delivered to

Innodisk P/N

Description

All Innodisk EP Products

- ☐ contain(s) **no** hazardous substances or constituents exceeding the defined threshold 0.1 % by weight in homogenous material if not otherwise specified, as described in the candidate list table currently including 209 substances and shown on the ECHA website (<http://echa.europa.eu/de/candidate-list-table>).
- ☒ contain(s) one or more hazardous substances or constituents exceeding 0.1 % by weight in homogenous material if not otherwise specified in candidate list table. Where the threshold value is exceeded, the substances in question are to be declared in accompanying Appendix A.
- ☒ Comply with REACH Annex XVII.

Guarantor

Company name 公司名稱： Innodisk Corporation 宜鼎國際股份有限公司Company Representative 公司代表人： Randy Chien 簡川勝Company Representative Title 公司代表人職稱： Chairman 董事長Date 日期： 2020 / 07 / 01

宜鼎國際股份有限公司

Innodisk Corporation

Tel:(02)7703-3000 Internet: <https://www.innodisk.com/>

RoHS 自我宣告書(RoHS Declaration of Conformity)

Manufacturer Products: All Innodisk EM FLASH, DRAM and EP products

- 一、 宜鼎國際股份有限公司（以下稱本公司）特此保證售予貴公司之所有產品，皆符合歐盟 2011/65/EU 及(EU) 2015/863 關於 RoHS 之規範要求。
Innodisk Corporation declares that all products sold to the company, are complied with European Union RoHS Directive (2011/65/EU) and (EU) 2015/863 requirement.
- 二、 本公司同意因本保證書或與本保證書相關事宜有所爭議時，雙方宜友好協商，達成協議。
Innodisk Corporation agrees that both parties shall settle any dispute arising from or in connection with this Declaration of Conformity by friendly negotiations.
- 三、 本公司聲明我們的產品符合 RoHS 指令的附件中(7a)、(7c-I)允許豁免。
We declare, our products permitted by the following exemptions specified in the Annex of the RoHS directive.
- ※ (7a) Lead in high melting temperature type solders(i.e. lead-based alloys containing 85% by weight or more lead).
- ※ (7C-I) Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectric devices, or in a glass or ceramic matrix compound.

Name of hazardous substance	Limited of RoHS ppm (mg/kg)
鉛 (Pb)	< 1000 ppm
汞 (Hg)	< 1000 ppm
鎘 (Cd)	< 100 ppm
六價鉻 (Cr 6+)	< 1000 ppm
多溴聯苯 (PBBs)	< 1000 ppm
多溴二苯醚 (PBDEs)	< 1000 ppm
鄰苯二甲酸二(2-乙基己基)酯 (DEHP)	< 1000 ppm
鄰苯二甲酸丁酯苯甲酯 (BBP)	< 1000 ppm
鄰苯二甲酸二丁酯 (DBP)	< 1000 ppm
鄰苯二甲酸二異丁酯 (DIBP)	< 1000 ppm

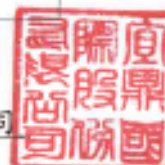
立 保 證 書 人 (Guarantor)

Company name 公司名稱: Innodisk Corporation 宜鼎國際股份有限公司

Company Representative 公司代表人: Randy Chien 簡川勝

Company Representative Title 公司代表人職稱: Chairman 董事長

Date 日期: 2020 / 03 / 03



Certificate

Issue Date: December 2, 2016
Ref. Report No. ISL-16LE568CE

Product Name : mPCIe to dual GbE PoE Module
Model(s) : E%PL-G#P1
(%: Form factor: (2: 2.5"SSD,3:DDR3
DIMM,D:Dongle,G:NGFF_M.2,H:mPCIe Half,L:PCIe Low
profile,M:mPCIe,S:PCIe Standard,X:Multi,Z:Others)
#: Output items: (1:1Port,2:2Ports,3:3Ports,4:4Ports,A~Z:TBD,X:Multi)
Responsible Party : Innodisk Corporation
Address : 5F., No.237, Sec. 1, Datong Rd., Xizhi Dist., New Taipei City 221, Taiwan
(R.O.C.)

We, **International Standards Laboratory**, hereby certify that:

The device bearing the trade name and model specified above has been shown to comply with the applicable technical standards as indicated in the measurement report and was tested in accordance with the measurement procedures specified in European Council Directive- EMC Directive 2014/30/EU. The device was passed the test performed according to :



Standards:

EN 55032:2015 and CISPR 32:2015
AS/NZS CISPR 32:2015
EN 61000-3-2:2014 and IEC 61000-3-2:2014
EN 61000-3-3: 2013 and IEC 61000-3-3: 2013
EN 55024: 2010+A1:2015 and CISPR 24: 2010+A1:2015
EN 61000-4-2: 2009 and IEC 61000-4-2: 2008
EN 61000-4-3: 2006+A1: 2008 +A2: 2010 and
IEC 61000-4-3:2006+A1: 2007+A2: 2010
EN 61000-4-4:2012 and IEC 61000-4-4:2012
EN 61000-4-5: 2014 and IEC 61000-4-5: 2014
EN 61000-4-6:2014+AC:2015 and IEC 61000-4-6:2013
EN 61000-4-8: 2010 and IEC 61000-4-8: 2009
EN 61000-4-11: 2004 and IEC 61000-4-11: 2004

I attest to the accuracy of data and all measurements reported herein were performed by me or were made under my supervision and are correct to the best of my knowledge and belief. I assume full responsibility for the completeness of these measurements and vouch for the qualifications of all persons taking them.

International Standards Laboratory

W.H. Chang / Director

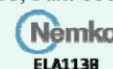
☐ Hsi-Chih LAB:

No. 65, Gu Dai Keng Street, Hsi-Chih Dist.,
New Taipei City 221, Taiwan
Tel: 886-2-2646-2550; Fax: 886-2-2646-4641



☒ Lung-Tan LAB:

No. 120, Lane 180, Hsin Ho Rd., Lung-Tan Dist.,
Tao Yuan City 325, Taiwan
Tel: 886-3-407-1718; Fax: 886-3-407-1738



Certificate

Issue Date: December 2, 2016

Ref. Report No. ISL-16LE568FA

Product Name : mPCIe to dual GbE PoE Module
 Model(s) : E%PL-G#P1
 (%: Form factor: (2: 2.5"SSD,3:DDR3 DIMM,D:Dongle,G:NGFF_M.2,H:mPCIe Half,L:PCIe Low profile,M:mPCIe,S:PCIe Standard,X:Multi,Z:Others)
 #: Output items: (1:1Port,2:2Ports,3:3Ports,4:4Ports,A~Z:TBD,X:Multi)
 Applicant : Innodisk Corporation
 Address : 5F., No.237, Sec. 1, Datong Rd., Xizhi Dist., New Taipei City 221, Taiwan (R.O.C.)

We, **International Standards Laboratory**, hereby certify that:

The device bearing the trade name and model specified above has been shown to comply with the applicable technical standards as indicated in the measurement report and was tested in accordance with the measurement procedures specified. (refer to Test Report if any modifications were made for compliance).



Standards:

FCC CFR Title 47 Part 15 Subpart B: 2015- Section 15.107 and 15.109

ANSI C63.4-2014

Industry Canada Interference-Causing Equipment Standard ICES-003 Issue 6: 2016

Class A

I attest to the accuracy of data and all measurements reported herein were performed by me or were made under my supervision and are correct to the best of my knowledge and belief. I assume full responsibility for the completeness of these measurements and vouch for the qualifications of all persons taking them.

International Standards Laboratory

W.H. Chang / Director

☐ Hsi-Chih LAB:

No. 65, Gu Dai Keng Street, Hsi-Chih Dist.,
 New Taipei City 221, Taiwan
 Tel: 886-2-2646-2550; Fax: 886-2-2646-4641



☒ Lung-Tan LAB:

No. 120, Lane 180, Hsin Ho Rd., Lung-Tan Dist.,
 Tao Yuan City 325, Taiwan
 Tel: 886-3-407-1718; Fax: 886-3407-1738



Contact us

Headquarters (Taiwan)

5F., No. 237, Sec. 1, Datong Rd., Xizhi Dist., New Taipei City 221, Taiwan

Tel: +886-2-77033000

Email: sales@innodisk.com

Branch Offices:

USA

usasales@innodisk.com

+1-510-770-9421

Europe

eusales@innodisk.com

+31-40-3045-400

Japan

jpsales@innodisk.com

+81-3-6667-0161

China

sales_cn@innodisk.com

+86-755-2167-3689

www.innodisk.com

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December 28, 2022